74LVC169

Presettable synchronous 4-bit up/down binary counter

Rev. 6 — 29 November 2012

Product data sheet

1. General description

The 74LVC169 is a synchronous presettable 4-bit binary counter which features an internal look-ahead carry circuitry for cascading in high-speed counting applications. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs (pins Q0 to Q3) change simultaneously with each other when so instructed by the count-enable (pins CEP and CET) inputs and internal gating. This mode of operation eliminates the output counting spikes that are normally associated with asynchronous (ripple clock) counters. A buffered clock (pin CP) input triggers the four flip-flops on the LOW-to-HIGH transition of the clock.

The counter is fully programmable; that is, the outputs may be preset to any number between 0 and its maximum count. Presetting is synchronous with the clock and takes place regardless of the levels of the count enable inputs. A LOW level on the parallel enable (pin $\overline{\text{PE}}$) input disables the counter and causes the data at the Dn input to be loaded into the counter on the next LOW-to-HIGH transition of the clock. The direction of the counting is controlled by the up/down (pin U/ $\overline{\text{D}}$) input. When pin U/ $\overline{\text{D}}$ is HIGH, the counter counts up, when LOW, it counts down.

The look-ahead carry circuitry is provided for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable (pins $\overline{\text{CEP}}$ and $\overline{\text{CET}}$) inputs and a terminal count (pin $\overline{\text{TC}}$) output. Both count-enable (pins $\overline{\text{CEP}}$ and $\overline{\text{CET}}$) inputs $\underline{\text{must}}$ be LOW to count. Input pin $\overline{\text{CET}}$ is fed forward to enable the terminal count (pin $\overline{\text{TC}}$) output. Pin $\overline{\text{TC}}$ thus enabled will produce a LOW-level output pulse with a duration approximately equal to a HIGH level portion of pin Q0 output. The LOW level pin $\overline{\text{TC}}$ pulse is used to enable successive cascaded stages.

The 74LVC169 uses edge triggered J-K type flip-flops and has no constraints on changing the control of data input signals in either state of the clock. The only requirement is that the various inputs attain the desired state at least a set-up time before the next LOW-to-HIGH transition of the clock and remain valid for the recommended hold time thereafter.

The parallel load operation takes <u>precedence</u> over the other operations, as indicated in the mode select table. When pin PE is LOW, the data on the input pins D0 to D3 enters the flip-flops on the next LOW-to-HIGH transition of the clock.



In order for counting to occur, both pins $\overline{\text{CEP}}$ and $\overline{\text{CET}}$ must be LOW and pin $\overline{\text{PE}}$ must be HIGH. The pin U/ $\overline{\text{D}}$ input determines the direction of the counting. The terminal count output pin $\overline{\text{TC}}$ output is parally HIGH and good 10W, provided that pin $\overline{\text{CET}}$ is LOW.

Presettable synchronous 4-bit up/down binary counter

output pin \overline{TC} output is normally HIGH and goes LOW, provided that pin \overline{CET} is LOW, when a counter reaches 15 in the count up mode. The pin \overline{TC} output state is not a function of the count-enable parallel (pin \overline{CEP}) input level. Since pin \overline{TC} signal is derived by decoding the flip-flop states, there exists the possibility of decoding spikes on pin \overline{TC} . For this reason the use of pin \overline{TC} as a clock signal is not recommended; see the following logic equations:

```
count enable = \overline{CEP} \bullet \overline{CET} \bullet \overline{PE}

count up: TC = Q3 \bullet Q2 \bullet Q1 \bullet Q0 \bullet CET \bullet U/\overline{D}

count down: TC = \overline{Q3} \bullet \overline{Q2} \bullet \overline{Q1} \bullet \overline{Q0} \bullet CET \bullet \overline{U}/D
```

2. Features and benefits

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Up/down counting
- Two count enable inputs for n-bit cascading
- Built-in look-ahead carry capability
- Presettable for programmable operation
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

Product data sheet

2 of 24

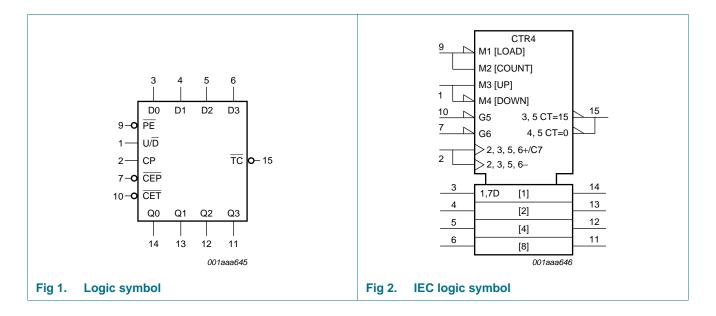
Presettable synchronous 4-bit up/down binary counter

3. Ordering information

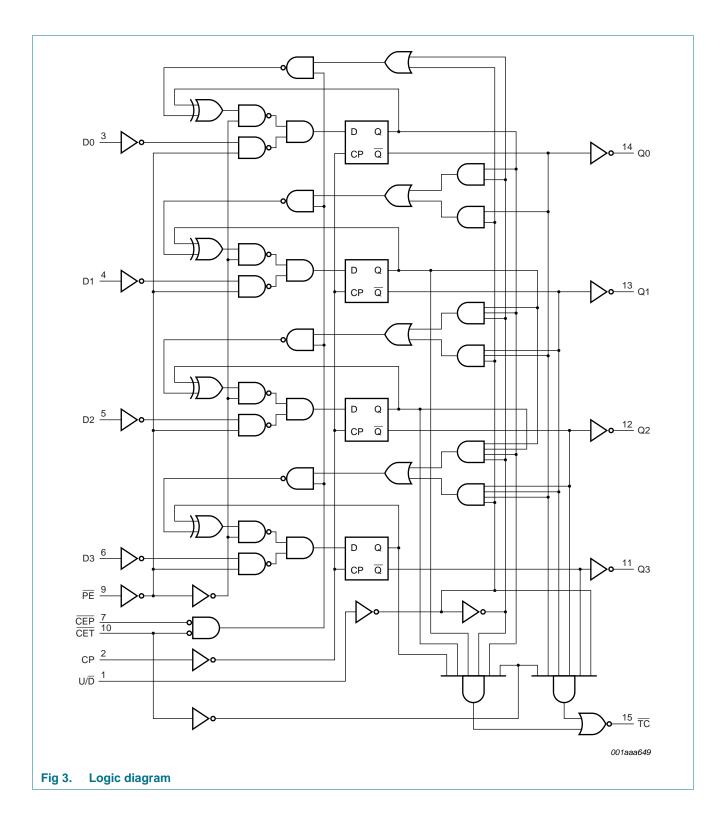
Table 1. Ordering information

Type number	Temperature range	Package	Package						
		Name	Description	Version					
74LVC169D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74LVC169DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1					
74LVC169PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					
74LVC169BQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 \times 3.5 \times 0.85 mm	SOT763-1					

4. Functional diagram



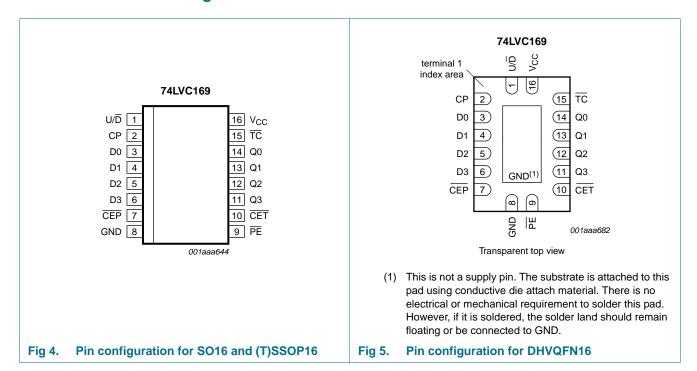
Presettable synchronous 4-bit up/down binary counter



Presettable synchronous 4-bit up/down binary counter

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
U/D	1	up/down control input
СР	2	clock input (LOW-to-HIGH, edge-triggered)
D0 to D3	3, 4, 5, 6	data input
CEP	7	count enable input (active LOW)
GND	8	ground (0 V)
PE	9	parallel enable input (active LOW)
CET	10	count enable carry input (active LOW)
Q0 to Q3	14, 13, 12, 11	flip-flop output
TC	15	terminal count output (active LOW)
V _{CC}	16	supply voltage

Presettable synchronous 4-bit up/down binary counter

6. Functional description

Table 3. Function table[1]

Operating mode	Input		Output	Output				
	СР	U/D	CEP	CET	PE	Dn	Qn	TC
Parallel load (Dn to Qn)	\uparrow	Χ	Χ	Χ	I	I	L	*
	\uparrow	Х	Χ	Χ	I	h	Н	*
Count up (increment)	↑	h	I	I	h	Х	count up	*
Count down (decrement)	↑	I	I	I	h	Х	count down	*
Hold (do nothing)	↑	Χ	h	Χ	h	Χ	qn	*
	\uparrow	Χ	Χ	Χ	h	Χ	qn	Н

[1] H = HIGH voltage level steady state

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition

L = LOW voltage level steady state

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition

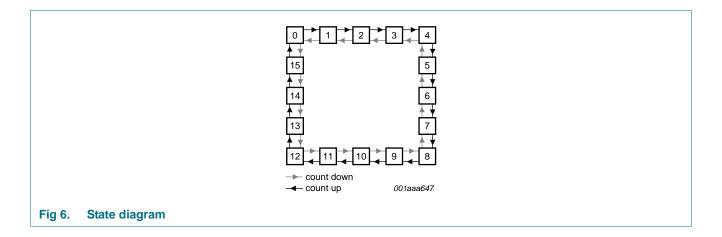
qn = Lower case letters indicate state of referenced output prior to the LOW-to-HIGH clock transition

X = don't care

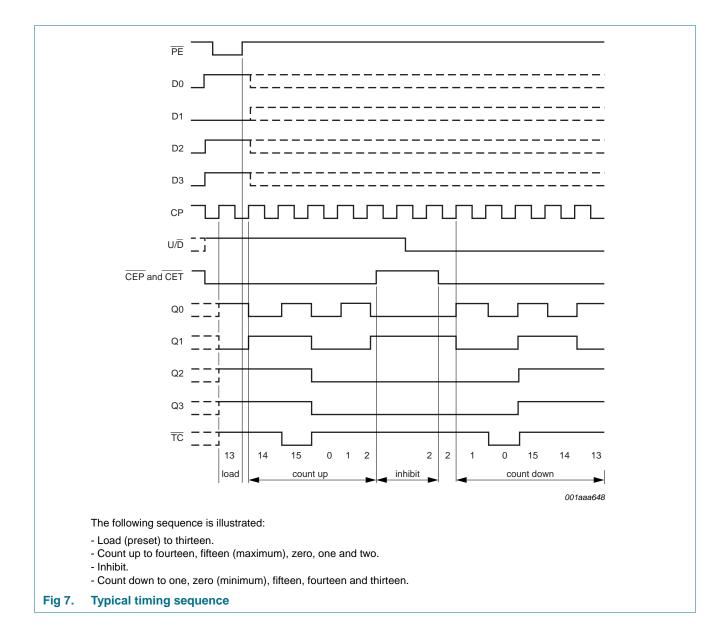
↑ = LOW-to-HIGH clock transition

* = The \overline{TC} is LOW when \overline{CET} is LOW and the counter is at terminal count

Terminal count up is (HHHH) and terminal count down is (LLLL)



Presettable synchronous 4-bit up/down binary counter



Product data sheet

7 of 24

Presettable synchronous 4-bit up/down binary counter

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
V_{I}	input voltage		<u>[1]</u> –0.5	+5.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0 \text{ V}$	-	±50	mA
Vo	output voltage		[2] -0.5	$V_{CC} + 0.5$	V
Io	output current		-	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3] _	500	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V_{I}	input voltage		0	-	5.5	V
Vo	output voltage		0	-	V_{CC}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO16 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.
For (T)SSOP16 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.
For DHVQFN16 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

74LVC169 **NXP Semiconductors**

Presettable synchronous 4-bit up/down binary counter

Static characteristics

Table 6.

Static characteristics At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	8.0	-	8.0	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.2	-	-	V _{CC} - 0.3	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	8.0	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I _I	input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μА
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$	-	0.1	10	-	40	μΑ
Δl _{CC}	additional supply current	per input pin; V_{CC} = 2.7 V to 3.6 V; V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A	-	5	500	-	5000	μΑ
C _I	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_I = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

Presettable synchronous 4-bit up/down binary counter

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	CP to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	17	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.5	7.1	13.1	1.5	15.1	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.4	4.1	7.4	2.4	8.6	ns
		V _{CC} = 2.7 V		1.5	3.9	7.2	1.5	9.0	ns
		V _{CC} = 3.0 V to 3.6 V		1.5	3.7	6.6	1.5	10.0	ns
		CP to TC; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	21	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.0	8.5	14.9	2.0	17.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		3.0	4.9	8.4	3.0	9.7	ns
		V _{CC} = 2.7 V		1.5	4.7	8.8	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	4.4	7.5	1.5	9.5	ns
		CET to TC; see Figure 9	[2]						
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.5	6.6	12.3	1.5	14.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.2	3.8	7.0	2.2	8.1	ns
		V _{CC} = 2.7 V		1.5	4.0	7.2	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.4	6.2	1.5	8.0	ns
		U/D to TC; see Figure 10	[2]						
		V _{CC} = 1.2 V		-	21	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.0	7.3	13.7	1.0	15.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	4.2	7.7	1.7	8.9	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	4.4	8.2	1.5	10.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	3.8	6.9	1.5	9.0	ns
t_{W}	pulse width	CP HIGH or LOW; see Figure 8							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		6.0	-	-	6.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		5.0	-	-	5.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		5.0	-	-	5.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		4.0	1.2	-	4.0	-	ns

Product data sheet

10 of 24

Presettable synchronous 4-bit up/down binary counter

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t_{su}	set-up time	Dn to CP; see Figure 11							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		5.5	-	-	5.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		4.5	-	-	4.5	-	ns
		$V_{CC} = 2.7 \text{ V}$		3.0	-	-	3.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.5	1.0	-	2.5	-	ns
		PE to CP; see Figure 11							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		4.5	-	-	4.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		3.5	-	-	3.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		3.0	1.2	-	3.0	-	ns
		U/D to CP; see Figure 12							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		9.0	-	-	9.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		7.0	-	-	7.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		6.5	-	-	6.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		5.5	2.8	-	5.5	-	ns
		CEP, CET to CP; see Figure 12							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		9.0	-	-	9.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		6.0	-	-	6.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		5.5	-	-	5.5	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		4.5	2.1	-	4.5	-	ns
t _h	hold time	Dn, PE, CEP, CET, U/D to CP; see Figure 11 and 12							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	-	-	1.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	-	-	1.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		0.0	-	-	0.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.5	0.0	-	0.5	-	ns
f _{max}	maximum	see <u>Figure 8</u>							
	frequency	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		100	-	-	80	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		125	-	-	100	-	MHz
		$V_{CC} = 2.7 \text{ V}$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		150	200	-	120	-	MHz
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns

Presettable synchronous 4-bit up/down binary counter

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 13.

Symbol	Parameter	Conditions		-40 °C to +85 °C			–40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
C _{PD} power dissipation capacitance	per input pin; $V_I = GND$ to V_{CC}	[4]				•			
	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	12.7	-	-	-	pF	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	16.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	19.7	-	-	-	pF

- [1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.2$ V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \sum (C_L \times V_{CC}{}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

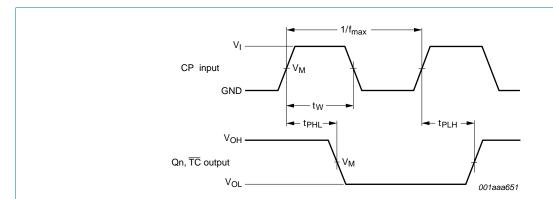
C_L = output load capacitance in pF

V_{CC} = supply voltage in Volt

N = number of inputs switching

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs}$

11. Waveforms



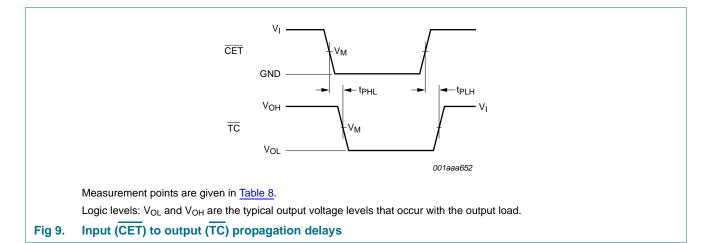
Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 8. Clock (CP) to outputs (Qn, TC) propagation delays, the clock pulse width, and the maximum frequency

74LVC169 **NXP Semiconductors**

Presettable synchronous 4-bit up/down binary counter



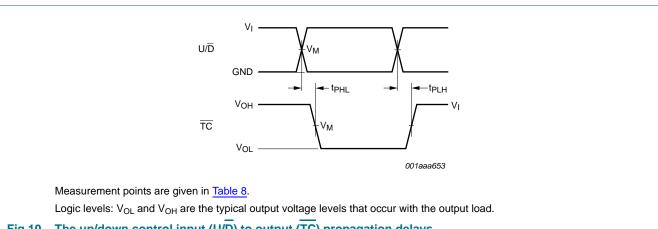
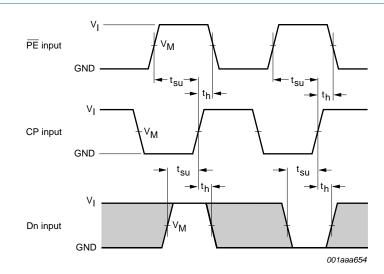


Fig 10. The up/down control input (U/\overline{D}) to output (\overline{TC}) propagation delays

Product data sheet

13 of 24

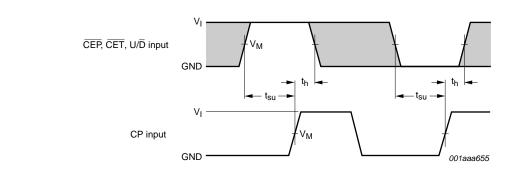
Presettable synchronous 4-bit up/down binary counter



The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 11. Set-up and hold times for the input (Dn) and parallel enable input (PE)



The shaded areas indicate when the input is permitted to change for predictable output performance. Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

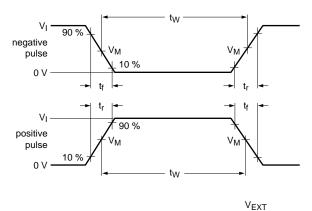
Fig 12. Set-up and hold times for count enable inputs (CEP and CET) and control input (U/D)

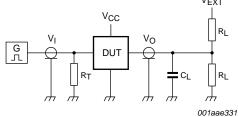
Table 8. Measurement points

Supply voltage	Input		Output	
V _{CC}	VI	V _M	V _M	
1.2 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	
1.65 V to 1.95 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	
2.3 V to 2.7 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	
2.7 V	2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	

74LVC169

Presettable synchronous 4-bit up/down binary counter





Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 13. Test circuit for measuring switching times

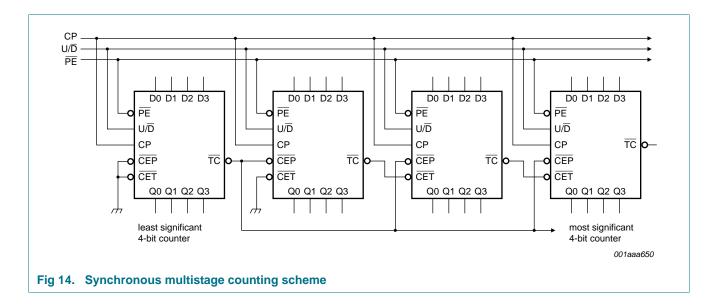
Table 9. Test data

Supply voltage	Input		Load		S1 position
V _{CC}	V _I	t _r , t _f	C _L	R _L	t _{PLH} , t _{PHL}
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ <mark>[1]</mark>	open
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ <mark>[1]</mark>	open
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500 Ω	open
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open

[1] The circuit performs better when R_L = 1000 $k\Omega.$

Presettable synchronous 4-bit up/down binary counter

12. Application information

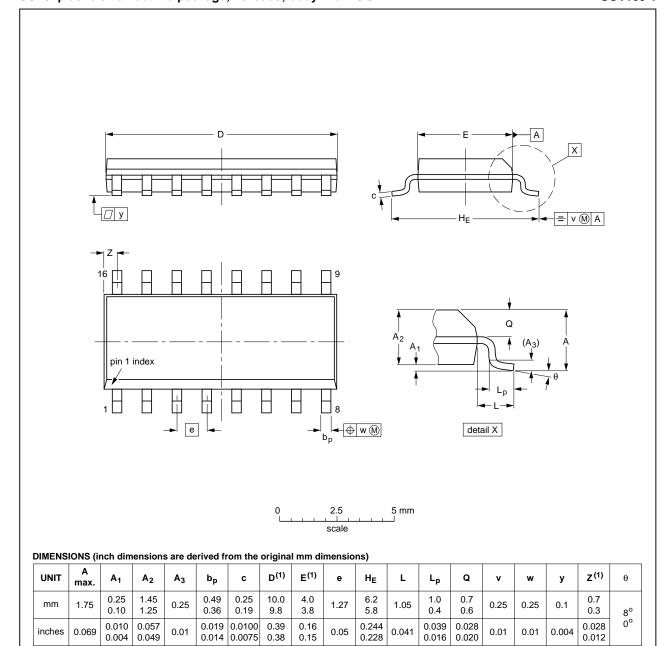


Presettable synchronous 4-bit up/down binary counter

13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION		REFER	EUROPEAN	ICCUIT DATE		
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				99-12-27 03-02-19

Fig 15. Package outline SOT109-1 (SO16)

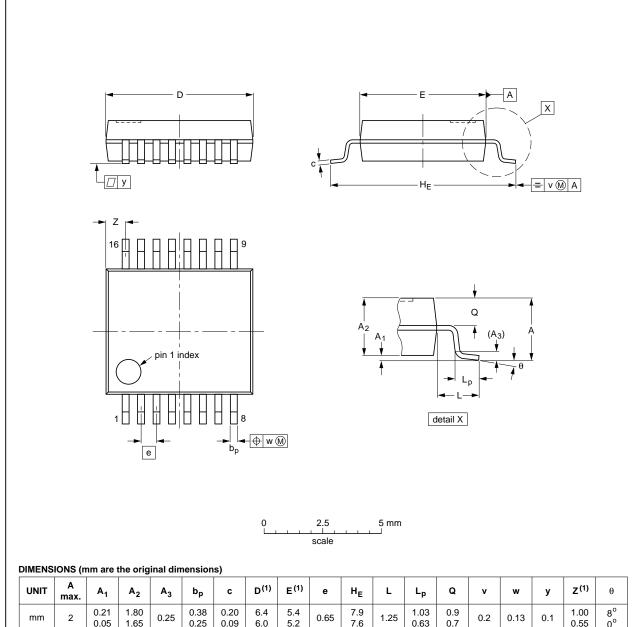
LVC169 All information provided in this document is subject to legal disclaimers.

74LVC169 **NXP Semiconductors**

Presettable synchronous 4-bit up/down binary counter

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	Ф	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE		
SOT338-1		MO-150				99-12-27 03-02-19		

Fig 16. Package outline SOT338-1 (SSOP16)

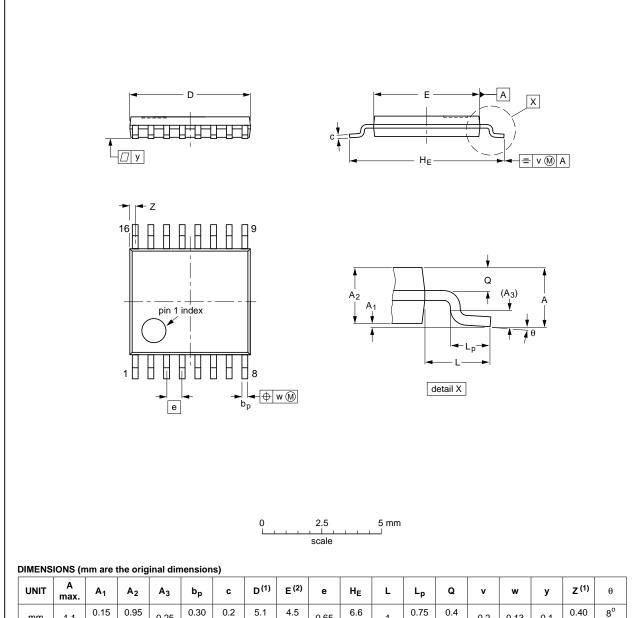
All information provided in this document is subject to legal disclaimers.

74LVC169 **NXP Semiconductors**

Presettable synchronous 4-bit up/down binary counter

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	1330E DATE		
SOT403-1		MO-153			99-12-27 03-02-18		

Fig 17. Package outline SOT403-1 (TSSOP16)

All information provided in this document is subject to legal disclaimers.

Presettable synchronous 4-bit up/down binary counter

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

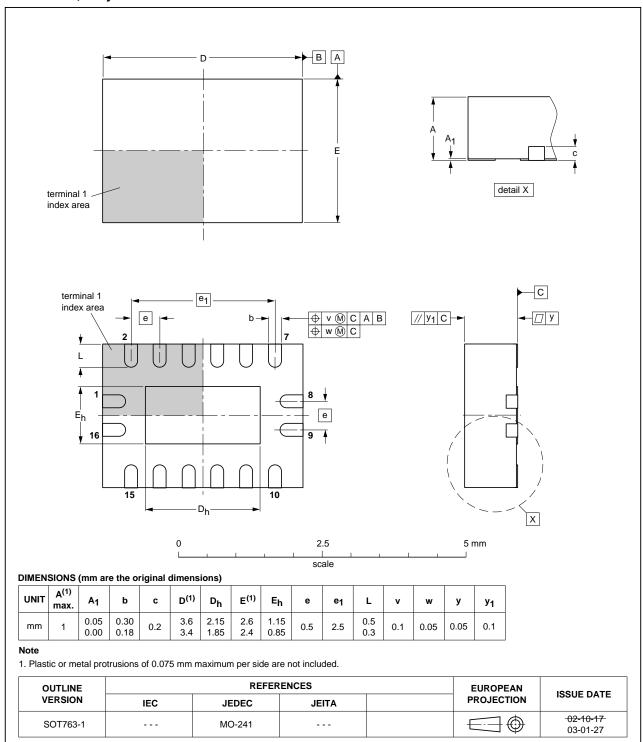


Fig 18. Package outline SOT763-1 (DHVQFN16)

74LVC169 All information provided in this document is subject to legal disclaimers.

Presettable synchronous 4-bit up/down binary counter

14. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC169 v.6	20121129	Product data sheet	-	74LVC169 v.5
Modifications:	• <u>Table 4</u> , <u>Table ranges</u> .	ole <u>5, Table 6, Table 7, Table</u>	e 8 and Table 9: values	added for lower voltage
74LVC169 v.5	20090608	Product data sheet	-	74LVC169 v.4
74LVC169 v.4	20041014	Product specification	-	74LVC169 v.3
74LVC169 v.3	20040512	Product specification	-	74LVC169 v.2
74LVC169 v.2	19980520	Product specification	-	74LVC169 v.1
74LVC169 v.1	19960823	Product specification	-	-

Product data sheet

Presettable synchronous 4-bit up/down binary counter

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

16.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

16.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

74LVC169

All information provided in this document is subject to legal disclaimers.

Presettable synchronous 4-bit up/down binary counter

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

17. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

Presettable synchronous 4-bit up/down binary counter

18. Contents

1	General description
2	Features and benefits
3	Ordering information
4	Functional diagram 3
5	Pinning information
5.1	Pinning
5.2	Pin description 5
6	Functional description 6
7	Limiting values 8
8	Recommended operating conditions 8
9	Static characteristics 9
10	Dynamic characteristics
11	Waveforms
12	Application information
13	Package outline
14	Abbreviations
15	Revision history
16	Legal information
16.1	Data sheet status
16.2	Definitions
16.3	Disclaimers
16.4	Trademarks23
17	Contact information 23
10	Contonte

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2012.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 29 November 2012 Document identifier: 74LVC169